

## **RECORDATION COVER SHEET - PATENT APPLICATION**

NAME OF CONVEYING PARTY

: Takashi OHSUMI

NAME OF RECEIVING PARTY

: Oki Electric Industry Co., Ltd.

ADDRESS OF RECEIVING PARTY:

7-12, Toranomon 1-chome, Minato-ku,

Tokyo, Japan

NATURE OF CONVEYANCE

: Assignment of U.S. patent application

12.30.03

10747317

CONVEYANCE EXECUTION DATE

: December 3, 2003

PATENT APPLICATION NO.

: To Be Assigned

APPLICATION FILED TOGETHER

WITH THIS DOCUMENT

: Yes

APPLICATION EXECUTION DATE

: December 3, 2003

**CORRESPONDENCE ADDRESS** 

: RABIN & BERDO, P.C.

1101 14<sup>th</sup> Street, N.W., Suite 500

Washington, D.C. 20005

ATTORNEY REFERENCE

: OKI 400

TOTAL NUMBER OF PATENTS

AND APPLICATIONS INVOLVED

: One

**TOTAL FEE PAID** 

: \$40.00

METHOD OF PAYMENT

: [X] Enclosed

[ ] Authorized to be charged to

deposit account

In the event there is attached hereto no check, or a check for an insufficient amount, please charge the fee to our Account No. 18-0002 and notify us accordingly.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert H. Berdo, Jr.

(Registration No. 38,075)

Data

RHB:rw

Total number of pages including cover sheet, attachments and document: 2

01/06/2004 SSITHIB1 00000062 10747317

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PATENT REEL: 014860 FRAME: 0587

	Attorney Reference
ASSIGNMENT OF APPLICATION	FOR UNITED STATES LETTERS PATENT
WHEREAS Takashi OHSUMI	
ereinafter referred to collectively as the assignor, h	
elating to SEMICONDUCTOR DEVICE AND	METHOD FOR MANUFACTURING THE SAME
	on being executed concurrently with the execution of this
nstrument; said application to be filed in the United	
] said application having been filed in the United	
authorization being hereby g	iven to my attorneys, Steven M. Rabin, Robert H. Berdo,
	C, 1101 14th Street, Suite 500, Washington, D.C. 20005, to
nsert here in parentheses (Application Serial No.	anlication when known:
) the application serial number of said ap ] said application having been filed under the Pat	
Gerial No. ), the Ui	pited States of America being designated
, the Oi	med States of Afficiaca being designated.
AND WHEREAS Oki Electric Industry Co., Ltd	
	ne, Minato-ku, Tokyo, Japan s of acquiring the entire right, title and interest in and to said
	tinuations thereof, and in and to said invention and any and
	any and all renewals, reissues and prolongations thereof;
	consideration of One Dollar (\$1.00), and other good and
	aid assignor, the receipt of which is hereby acknowledged,
	s to said assignee, and said assignee's successors and
	st in and to said application, including any and all divisions
and continuations thereof, and in and to said invent	tion and any and all patents which may be granted therefor,
	olongations thereof; said assignee, and said assignee's
	nd enjoy the said application, including any and all divisions
	and any and all patents which may be granted therefor,
	ngations thereof, with all the rights, powers, privileges and
	thereto, for and during the term or terms of any and all such
	wals, reissues and prolongations thereof, for the use and
	essors and assigns, in as ample and beneficial a manner as
	yed the same, if this assignment had not been made. m, upon the request of said assignee, or said assignee's
	the obtaining or to the asserting of said patents, including
iny and all renewals, reissues and prolongations the	
	s the Commissioner of Patents and Trademarks to issue
etters Patent on said application, and on any and a	
o said assignee, and said assignee's successors a	
<b>A</b>	
EXECUTED, <u>Locember</u>	J, 2003
	ASSIGNOR:
Signature: Yasur Sanaka	70 0 M
Signature:	Signature:
	Name: Takashi OHSUMI

RABIN & BERDO, P.C.

**RECORDED: 12/30/2003** 

**ASSIGNMENT OF APPLICATION FOR UNITED STATES LETTERS PATENT** 

PATENT REEL: 014860 FRAME: 0588